

Title (en)  
SUBSTRATE HOLDER AND METHOD FOR BONDING TWO SUBSTRATES

Title (de)  
SUBSTRATHALTER UND VERFAHREN ZUM BONDEN ZWEIER SUBSTRATE

Title (fr)  
DISPOSITIF ET PROCÉDÉ POUR RELIER DEUX SUBSTRATS

Publication  
**EP 3281220 A1 20180214 (DE)**

Application  
**EP 15717136 A 20150410**

Priority  
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Abstract (en)  
[origin: WO2016162088A1] The invention relates to a substrate holder (1, 1', 1", 1"', 1IV), comprising a fixing surface (4o) for holding a substrate (11, 11').

IPC 8 full level  
**H01L 21/67** (2006.01)

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**H01L 21/187** (2013.01 - KR); **H01L 21/67092** (2013.01 - EP KR US); **H01L 21/67109** (2013.01 - EP KR US); **H01L 21/67346** (2013.01 - US); **H01L 21/68** (2013.01 - US); **H01L 24/80** (2013.01 - US)

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JP 2005302858 A 20051027 - NIKON CORP

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